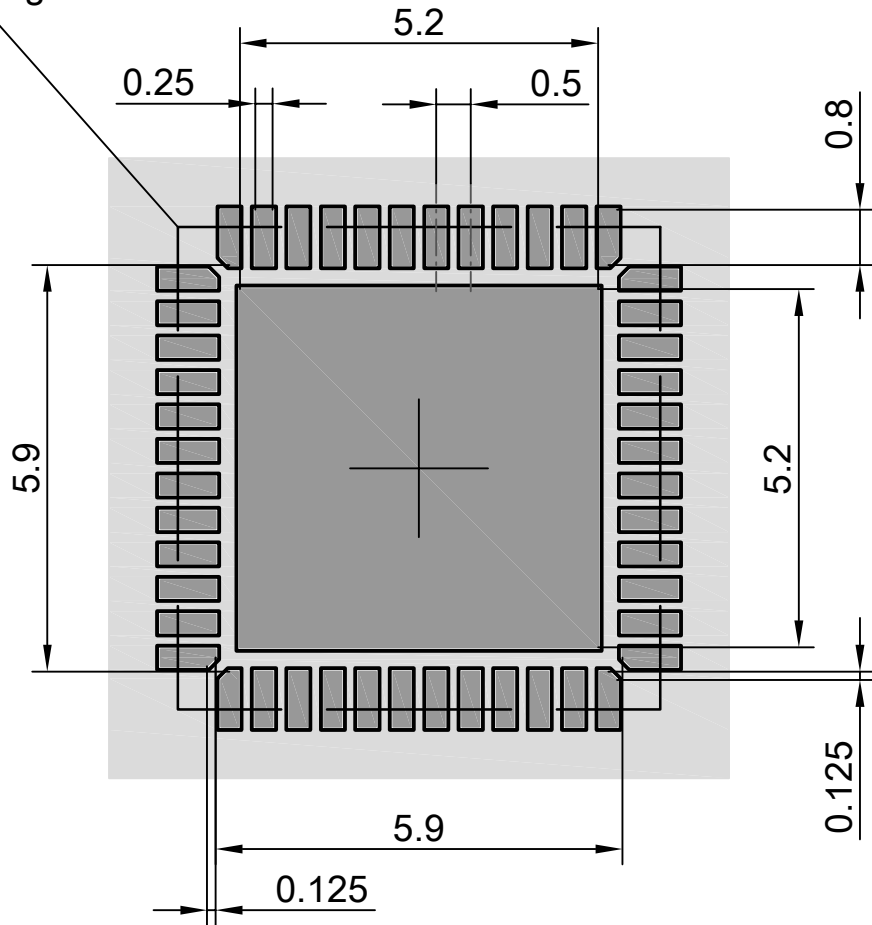



Package Outline 7x7

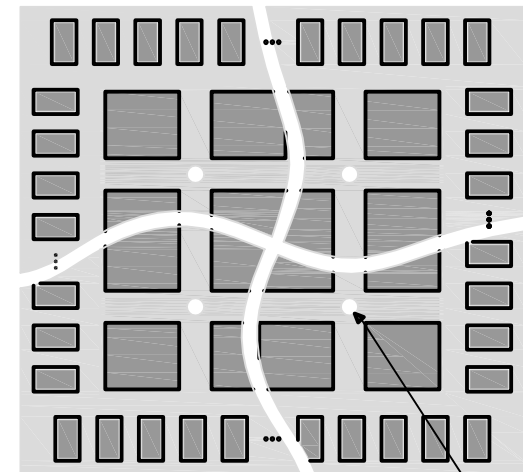


 copper

 solder mask

ALL DIMENSIONS ARE IN UNITS MM

Optional Thermal pad design for via integration



Space for via hole